

12-26-01

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Atty. Docket No. AMAT/5813/ETCH/METAL/JB

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application  
 Assistant Commissioner of Patents and Trademarks  
 Washington, D.C. 20231

Re: Inventor(s): Melisa Buie; Brigitte Stoehr; and Guenther Ruhl  
 Title: ETCH PROCESS FOR PHOTOLITHOGRAPHIC RETICLE  
 MANUFACTURING WITH IMPROVED ETCH BIAS

Jc720 U.S. PTO  
 10/024958  
 12/18/01

Transmitted herewith is the patent application identified above, including:

- ☒ Specification, claims and abstract, totaling 24 pages.  
☒ Drawings totaling 3 pages, ☒ Formal \_\_\_ Informal.  
 \_\_\_ Executed Declaration and Power of Attorney.  
 \_\_\_ Information Disclosure Statement w/ Form 1449 and References.  
 \_\_\_ Assignment of the invention to **Applied Materials, Inc.**  
 \_\_\_ Assignment Recordation Cover Sheet

FEE CALCULATION					
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	24	-20=	4	x \$18.00	\$72.00
Independent Claims	3	-3=	0	x \$84.00	\$84.00
Basic Filing Fee				\$740.00	\$740.00
<b>TOTAL FEES</b>					<b>\$896.00</b>

- ☒ The Commissioner is hereby authorized to charge **\$896.00** to Deposit Account No. 50-1074/AMAT/5813/ETCH/METAL/JB.  
☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 50-1074/5813/ETCH/METAL/JB. A duplicate copy of this transmittal is enclosed.  
☒ Please address all future correspondence to:

**PATENT COUNSEL  
 APPLIED MATERIALS, INC.  
 Legal Affairs Department  
 P.O.BOX 450A  
 Santa Clara, CA. 95052**

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Commissioner for Patents, Box Patent Application, Washington, DC 20231.

Express Mail Receipt No. EV 041916383 US  
 Date of Deposit. 12-18-01  
 Signature: Robert W. Mulcahy

Respectfully submitted,

Robert W. Mulcahy  
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